## **DISCRETE SEMICONDUCTORS**

# DATA SHEET



## BB145B Low-voltage variable capacitance diode

Product specification Supersedes data of 2002 Nov 18 2004 Mar 29



## Low-voltage variable capacitance diode

**BB145B** 

#### **FEATURES**

- Ultra small plastic SMD package
- C4: 2.75 pF; ratio: 2.4
- Low series resistance.

#### **APPLICATIONS**

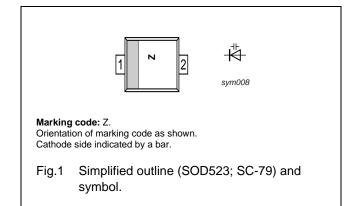
• Voltage controlled oscillators (VCO).

#### **DESCRIPTION**

The BB145B is a planar technology variable capacitance diode in a SOD523 (SC-79) package.

#### **PINNING**

PIN	DESCRIPTION	
1	cathode	
2	anode	



#### **ORDERING INFORMATION**

TYPE		PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION	
BB145B	_	plastic surface mounted package; 2 leads	SOD523	

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_R$	continuous reverse voltage		_	6	V
$V_{RM}$	peak reverse voltage	in series with a 10 kΩ resistor	_	8	V
I <sub>F</sub>	continuous forward current		_	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	operating junction temperature		-55	+150	°C

#### **ELECTRICAL CHARACTERISTICS**

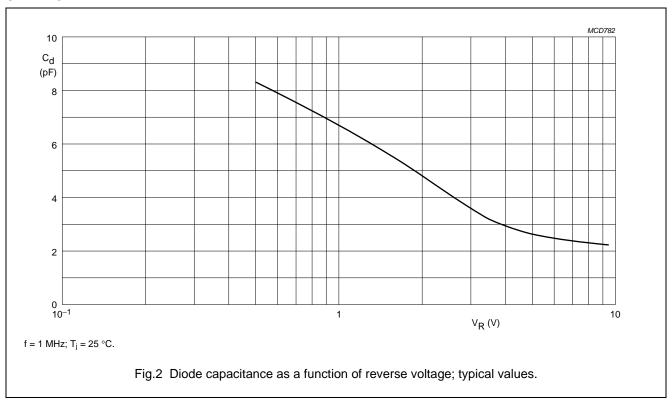
 $T_i = 25$  °C unless otherwise specified.

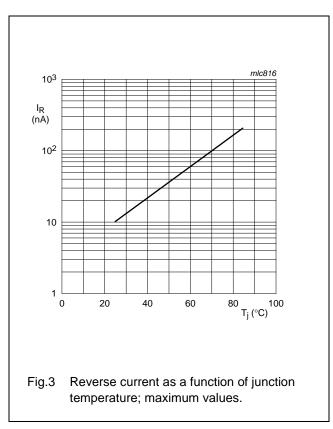
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>R</sub>	reverse current	V <sub>R</sub> = 6 V; see Fig.3	_	10	nA
		V <sub>R</sub> = 6 V; T <sub>j</sub> = 85 °C; see Fig.3	_	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz; V <sub>R</sub> = 1 V	_	0.6	Ω
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; see Figs 2 and 4	6.4	7.2	pF
		V <sub>R</sub> = 4 V; f = 1 MHz; see Figs 2 and 4	2.55	2.95	pF
$\frac{C_{d(1V)}}{C_{d(4V)}}$	capacitance ratio	f = 1 MHz	2.2	_	

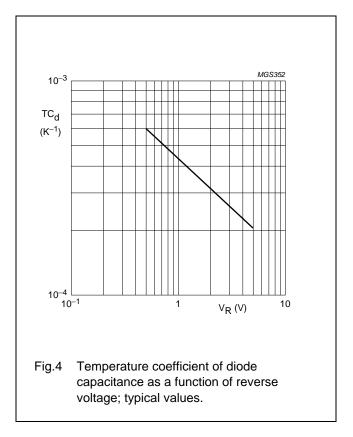
## Low-voltage variable capacitance diode

BB145B

#### **GRAPHICAL DATA**







## Low-voltage variable capacitance diode

BB145B

#### **PACKAGE OUTLINE**

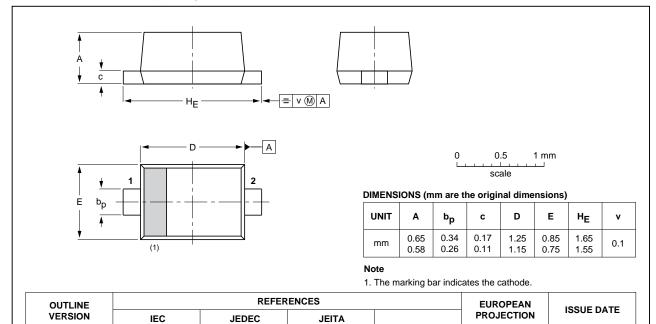
SOD523



**SOD523** 

02-12-13

06-03-16



SC-79

## Low-voltage variable capacitance diode

**BB145B** 

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
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#### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

For additional information please visit: http://www.nxp.com
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Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

## Customer Service :

Email service@ameya360.com

## Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com